

### **Technical Data Sheet**

# **Reverse Package Chip LED with Inner Lens**

### <u>25-21/T1D-APOHY/2A</u>

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

### **Descriptions**

- The 25-21 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

### **Applications**

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

### **Device Selection Guide**

Device No.: SZDSE-251-T02

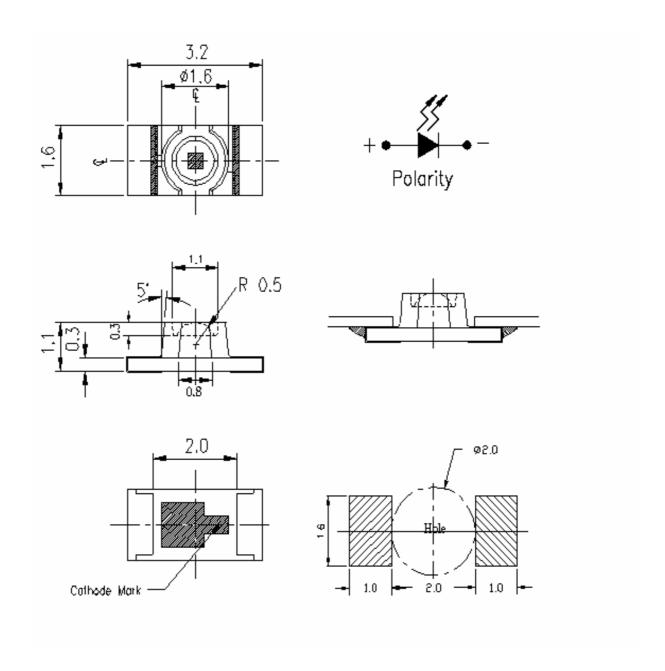
Don't No	Chip	Emitted Color	Resin Color	
Part No.	Material	Emitted Color		
25-21/T1D-APQHY/2A	InGaN	Pure White	Yellow Diffused	



Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 1 of 11

Prepared date:24-Jan-2008 Prepared by:Qilong Chen

# **Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Angle $\pm 0.5^{\circ}$ , Unit = mm

Everlight Electronics Co., Ltd.

Device No.: SZDSE-251-T02

http://www.everlight.com

Prepared date:24-Jan-2008

Rev. 1

Page: 2 of 11

Prepared by: Qilong Chen



## **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit	
Reverse Voltage	$V_{R}$	5	V	
Forward Current	${ m I_F}$	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	$ m I_{FP}$	100	mA	
Power Dissipation	$P_d$	95	mW	
Electrostatic Discharge(HBM)	ESD	150	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.		

# **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_{v}$	45.0		112.0	mcd	
Viewing Angle	$2 heta_{ ext{1/2}}$		70		deg	I <sub>F</sub> =20 mA
Forward Voltage	$V_{\mathrm{F}}$	2.7		3.15	V	
Reverse Current	$I_R$			50	μΑ	V <sub>R</sub> =5V

Bin Range Of Luminous Intensity & Forward Voltage

		·			
Symbol	Bin Code	Min.	Max.	Unit	Condition
	P	45.0	72.0	an a d	I <sub>F</sub> =5mA
	Q	72.0	112	mcd	
	15	2.70	0 2.85		
$V_{\mathrm{F}}$	16	2.85	3.00	V	$I_F=5mA$
	17	3.00	3.15		

### **Notes:**

1.Tolerance of Luminous Intensity ±15%

2.Tolerance of Forward Voltage ±0.1V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 3 of 11

Device No.: SZDSE-251-T02 Prepared date:24-Jan-2008 Prepared by: Qilong Chen



# **Chromaticity Coordinates Specifications for Bin Grading**

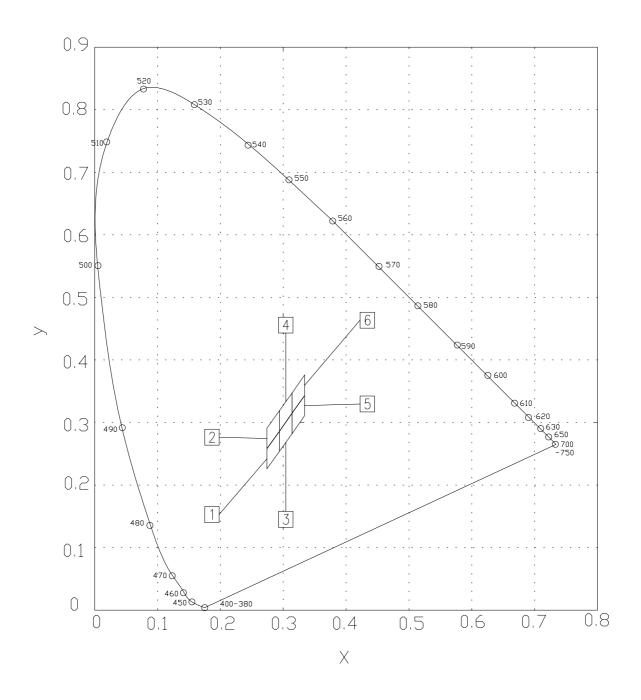
Groups	Bin Code	CIE_x	CIE_y	Condition
	1	0.274	0.226	
		0.274	0.258	
		0.294	0.286	
		0.294	0.254	
		0.274	0.258	
	2	0.274	0.291	
	2	0.294	0.319	
		0.294	0.286	
	3	0.294	0.254	
		0.294	0.286	
		0.314	0.315	
A		0.314	0.282	I <sub>F</sub> =5mA
A	4	0.294	0.286	IF–JIIIA
		0.294	0.319	
		0.314	0.347	
		0.314	0.315	
	5	0.314	0.282	
		0.314	0.315	
		0.334	0.343	
		0.334	0.311	
	6	0.314	0.315	
		0.314	0.347	
		0.334	0.376	
		0.334	0.343	

### **Notes:**

- 1.The C.I.E. 1931 chromaticity diagram (Tolerance ±0.01).
- 2. The products are sensitive to static electricity and care must be fully taken when handling products.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 4 of 11 Device No.: SZDSE-251-T02 Prepared date:24-Jan-2008 Prepared by: Qilong Chen

# **CIE Chromaticity Diagram**



Everlight Electronics Co., Ltd.

Device No.: SZDSE-251-T02

http://www.everlight.com

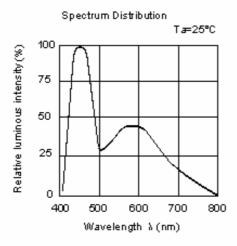
Prepared date:24-Jan-2008

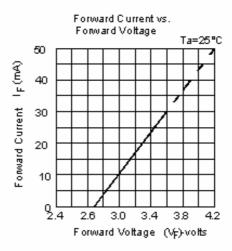
Rev. 1

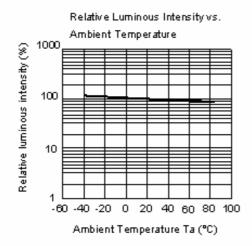
Page: 5 of 11

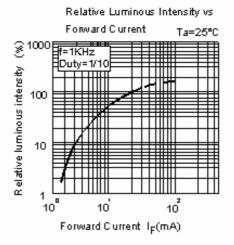
Prepared by: Qilong Chen

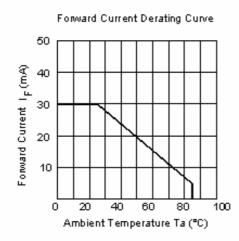
# **Typical Electro-Optical Characteristics Curves**

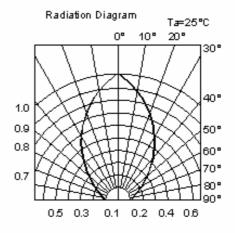








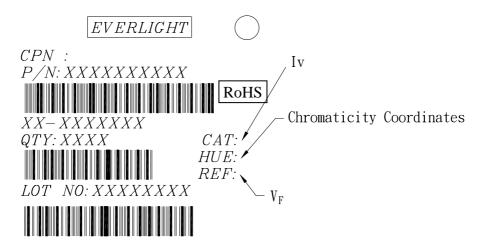




Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 6 of 11 Device No.: SZDSE-251-T02 Prepared date:24-Jan-2008 Prepared by: Qilong Chen

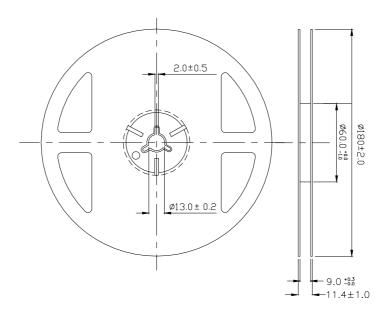
### Label explanation

CAT: Luminous Intensity (mcd) HUE: Chromaticity Coordinates REF: Forward Voltage (V)



MADE IN TAIWAN

### **Reel Dimensions**

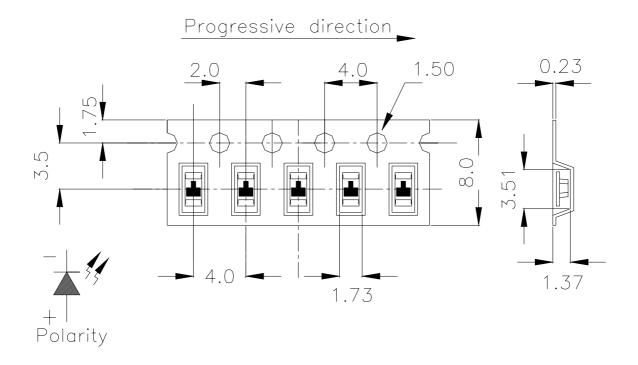


**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm ,Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 7 of 11

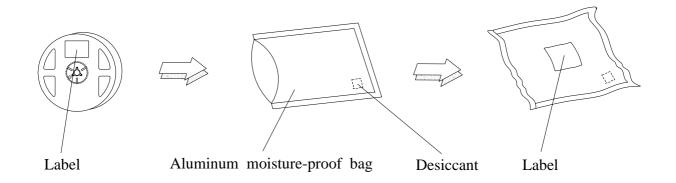
Device No.: SZDSE-251-T02 Prepared date:24-Jan-2008 Prepared by: Qilong Chen

# Carrier Tape Dimensions: Loaded quantity 2000 pcs per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

# **Moisture Resistant Packaging**



Everlight Electronics Co., Ltd.

Device No.: SZDSE-251-T02

http://www.everlight.com

Prepared date:24-Jan-2008

Rev. 1

Page: 8 of 11

Prepared by: Qilong Chen



## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90 %

LTPD: 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 9 of 11 Device No.: SZDSE-251-T02 Prepared date:24-Jan-2008 Prepared by: Qilong Chen

#### **Precautions For Use**

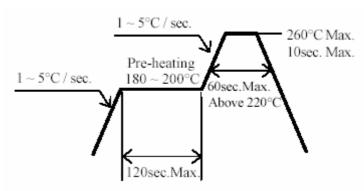
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

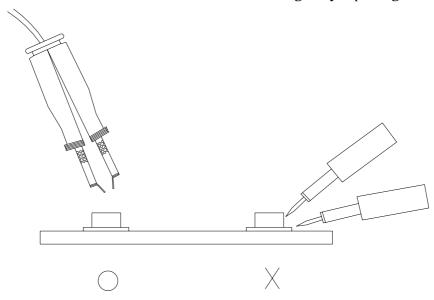
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 10 of 11

Device No.: SZDSE-251-T02 Prepared date:24-Jan-2008 Prepared by: Qilong Chen



### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 11 of 11

Device No.: SZDSE-251-T02 Prepared date:24-Jan-2008 Prepared by: Qilong Chen